

Customer Information Notification

Issue Date: 05-Mar-2020 Effective Date: 06-Mar-2020

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| Change Category | | | | |
|-----------------------|--------------------------|---------------------------------|----------------------|------------------------------------|
|] Wafer Fab Process | [] Assembly Process | [] Product Marking | [] Test Location | [] Design |
|] Wafer Fab Materials | [] Assembly Materials | [] Mechanical Specification | n[]Test Process | [] Errata |
|] Wafer Fab Location | [] Assembly Location | [] Packing/Shipping/Labeling | [] Test Equipment | [X] Electrical spec./Test coverage |
|] Firmware | [] Other | | | · · |

MPC5604E and MPC5606E Datasheet Update

Description

NXP Semiconductors announces Datasheet update for MPC5604E and MPC5606E. The revision history included in the updated documents provides a detailed description of the changes.

A file containing the summary of all changes to these documents is attached with this notification.

1. MPC5604E update from revision 5.1 to revision 6
The MPC5604E Datasheet revision 6 is attached to this notice and can be found at https://www.nxp.com/products/processors-and-microcontrollers/power-architecture/

https://www.nxp.com/products/processors-and-microcontrollers/power-architecture/mpc55xx-5xxx-mcus/ultra-reliable-mpc56xx-mcus/ultra-reliable-32-bit-mcu-for-automotive-adas-and-industrial-ethernet-applications:MPC560xE?tab=Documentation_Tab

2. MPC5606E update from revision 2 to revision 3

The MPC5606E Datasheet revision 3 is attached to this notice and can be found at https://www.nxp.com/products/processors-and-microcontrollers/power-architecture/mpc55xx-5xxx-mcus/ultra-reliable-mpc56xx-mcus/ultra-reliable-32-bit-mcu-for-automotive-adas-and-industrial-ethernet-applications:MPC560xE?tab=Documentation_Tab

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-03

Reason

The Datasheet has been updated to correct errors and provide additional technical clarification on some device features.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Data Sheet Revision

A new datasheet will be issued

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

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NXP Quality Management Team.

About NXP Semiconductors

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Affected Part Number

SPC5604EEF2MLH